

CURRENT 30 Ampere
VOLTAGE RANG 200 to 1000 Volts

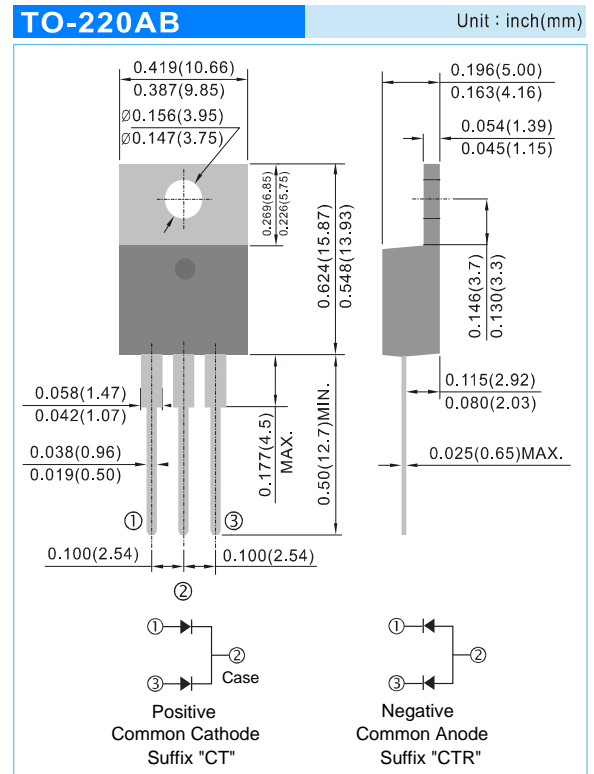
SF3004

FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-O. Flame Retardant Epoxy Molding Compound.
- Low power loss, high efficiency.
- Low forward voltage, high current capability
- High surge capacity.
- Super fast recovery times, high voltage.
- Epitaxial chip construction.
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)

MECHANICAL DATA

- Case: TO-220AB Molded plastic
- Terminals: Lead solderable per MIL-STD-750, Method 2026
- Polarity: As marked.
- Standard packaging: Any
- Weight: 0.067 ounces, 1.89 grams.



MAXIMUM RATING AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

| PARAMETER | SYMBOL | SF3002 | SF3004 | SF3006 | SF3008 | SF3010 | UNITS | |
|---|-----------------|-------------|--------|--------|--------|--------|-------|-----------------------------|
| Maximum Recurrent Peak Reverse Voltage | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V | |
| Maximum RMS Voltage | V_{RMS} | 140 | 280 | 420 | 560 | 700 | V | |
| Maximum DC Blocking Voltage | V_{DC} | 200 | 400 | 600 | 800 | 1000 | V | |
| Maximum Average Forward Current at $T_c=90^\circ\text{C}$ | $I_{F(AV)}$ | 30 | | | | | | A |
| Peak Forward Surge Current : 8.3ms single half sine-wave superimposed on rated load | I_{FSM} | 300 | | | | | | A |
| Maximum Forward Voltage at 15A | V_F | 0.95 | 1.3 | 1.5 | 1.7 | 1.9 | V | |
| Maximum DC Reverse Current at Rated DC Blocking Voltage $T_J=25^\circ\text{C}$ $T_J=100^\circ\text{C}$ | I_R | 10 500 | | | | | | μA |
| Maximum Reverse Recovery Time (Note 2) | t_{rr} | 35 | | | 50 | | ns | |
| Typical Junction Capacitance (Note 1) | C_J | 85 | | | | | | pF |
| Typical thermal Resistance (Note 3) | $R_{\theta Jc}$ | 3 | | | | | | $^\circ\text{C} / \text{W}$ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -50 to +150 | | | | | | $^\circ\text{C}$ |

NOTES :

1. Measured at 1 MHz and applied reverse voltage of 4 VDC.
2. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=0.25\text{A}$.
3. Both Bonding and Chip structure are available.

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SF3002 THRU SF3010

RATING AND CHARACTERISTIC CURVES

FIG.1 - FORWARD CURRENT DERATING CURVE

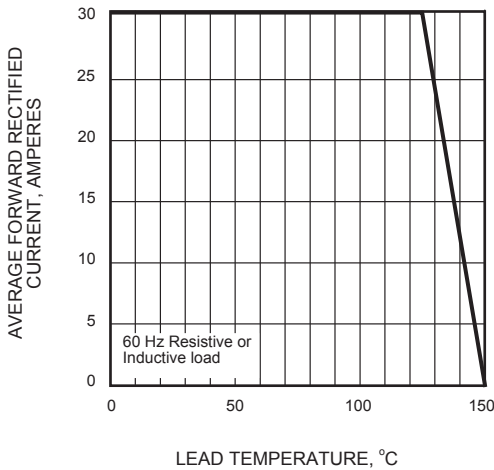


FIG.2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

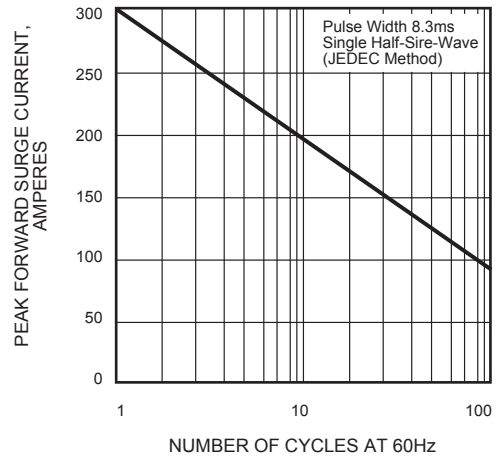


FIG.3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

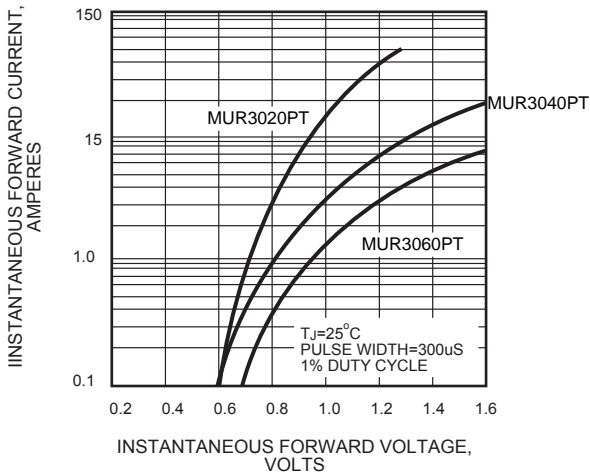


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

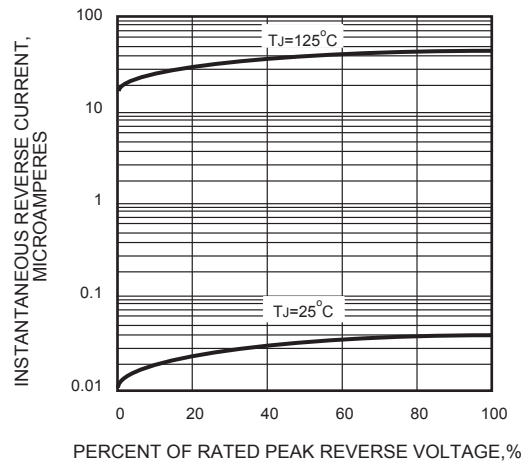


FIG.5 - TYPICAL JUNCTION CAPACITANCE

